

The Use of Life Cycle Assessment as a Screening Tool for Environmental Performance:

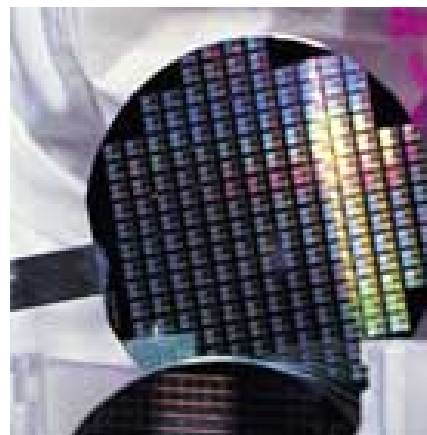
Supercritical Carbon Dioxide Use in the Semiconductor Industry

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Impact Analysis



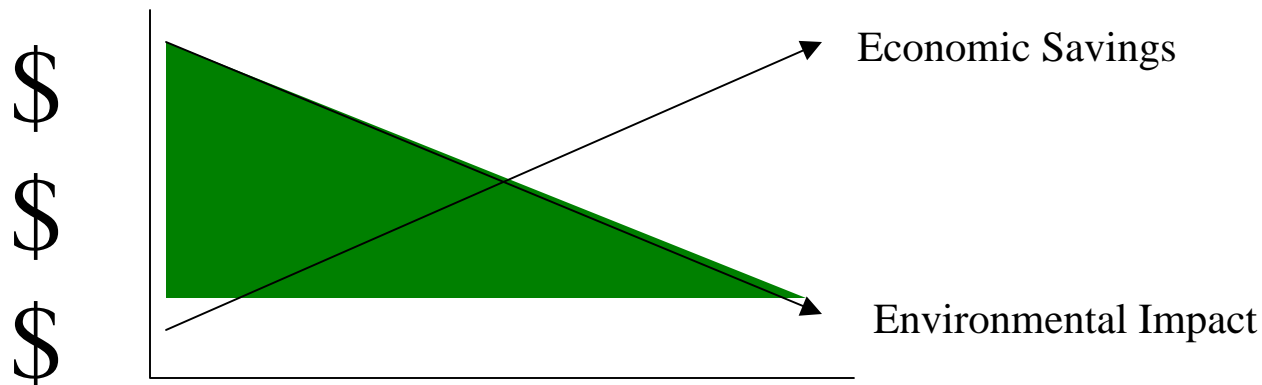
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Environmental/Economic Drivers for Process Innovation

Pollution treatment never makes money for the company running the processes

However, large savings can be made by avoiding the need for treatment in the first place

Considerations like these must take place at the design stage to be most effective



Get a reduction in costs while also improving the environmental performance of a process



Win/Win situations are possible



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Attractiveness of supercritical fluids in process applications

Can avoid organic solvents that are traditionally used in separations/reactions

less ozone depletion, toxicity, cost, separations, fossil fuel depletion

Can tune performance of sc fluids for enhanced properties

better reaction selectivity → separations afterwards

better or changeable solvent properties → less solvent need, better separations

Can use small amounts of additives to achieve better performance

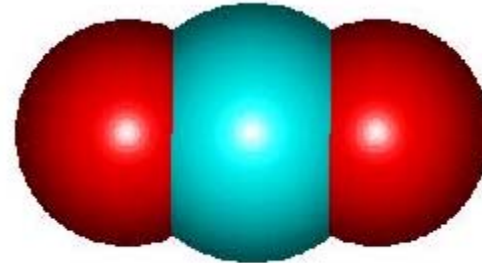
sometimes 100% recyclable → less cost

So, which fluids may be useful for semiconductor processing?



scCO₂ as a good choice? And, use of additives...

CO₂ is attractive for many reasons:



Its critical region is at fairly low pressures and temperatures compared to other materials → lower environmental and economic costs during its use

Using CO₂ may reduce overall CO₂ generation from other facilities depending on the source.

It has been used in many other industries so it is more familiar, may need additives.

Fragrance Extraction



Dry cleaning application



Remove bitterness from beer



Roadmap of ITRS

The International Technology Roadmap for Semiconductors (ITRS) is a plan for achieving better environmental, technical, and economic performance over the next several years and is continually updated.

ITRS says:

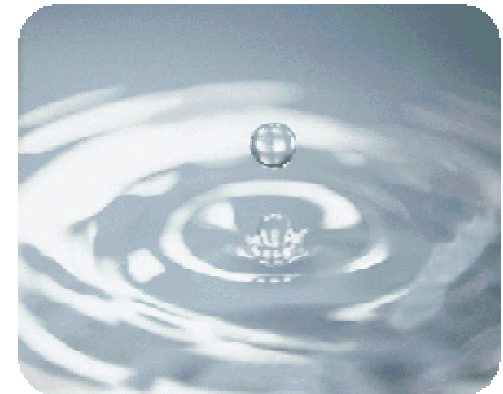
Develop processes that meet technology demands while reducing impacts

Develop effective management tools to deal with disposal

Design more energy and water efficient processing equipment

Reduce emissions from processing using GWP chemicals

Need integrated way to evaluate and quantify ESH impacts



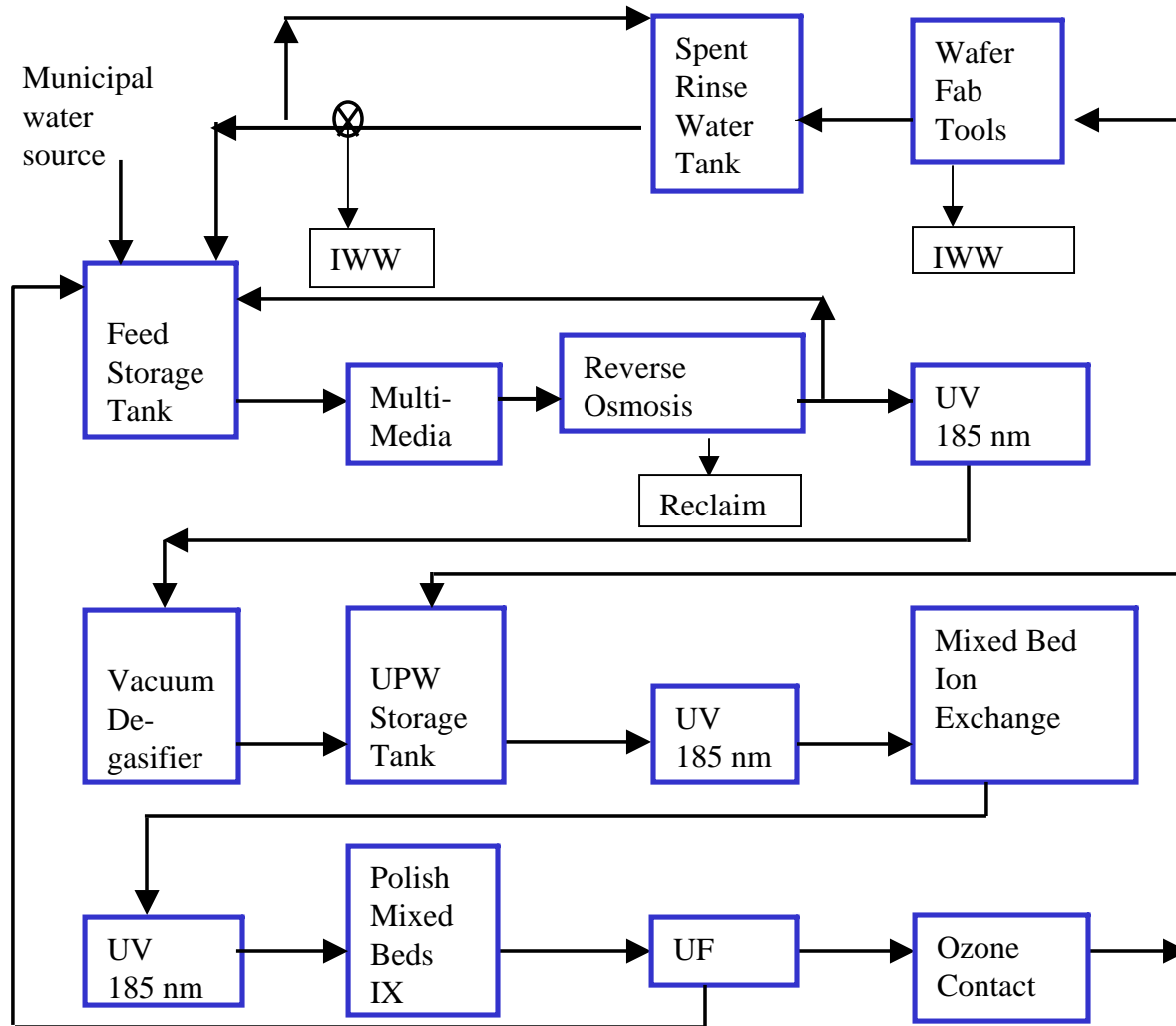
Specifically, reduce water usage by about 20% over the next three years

Reduce energy usage by about 40-50 % over the next three years

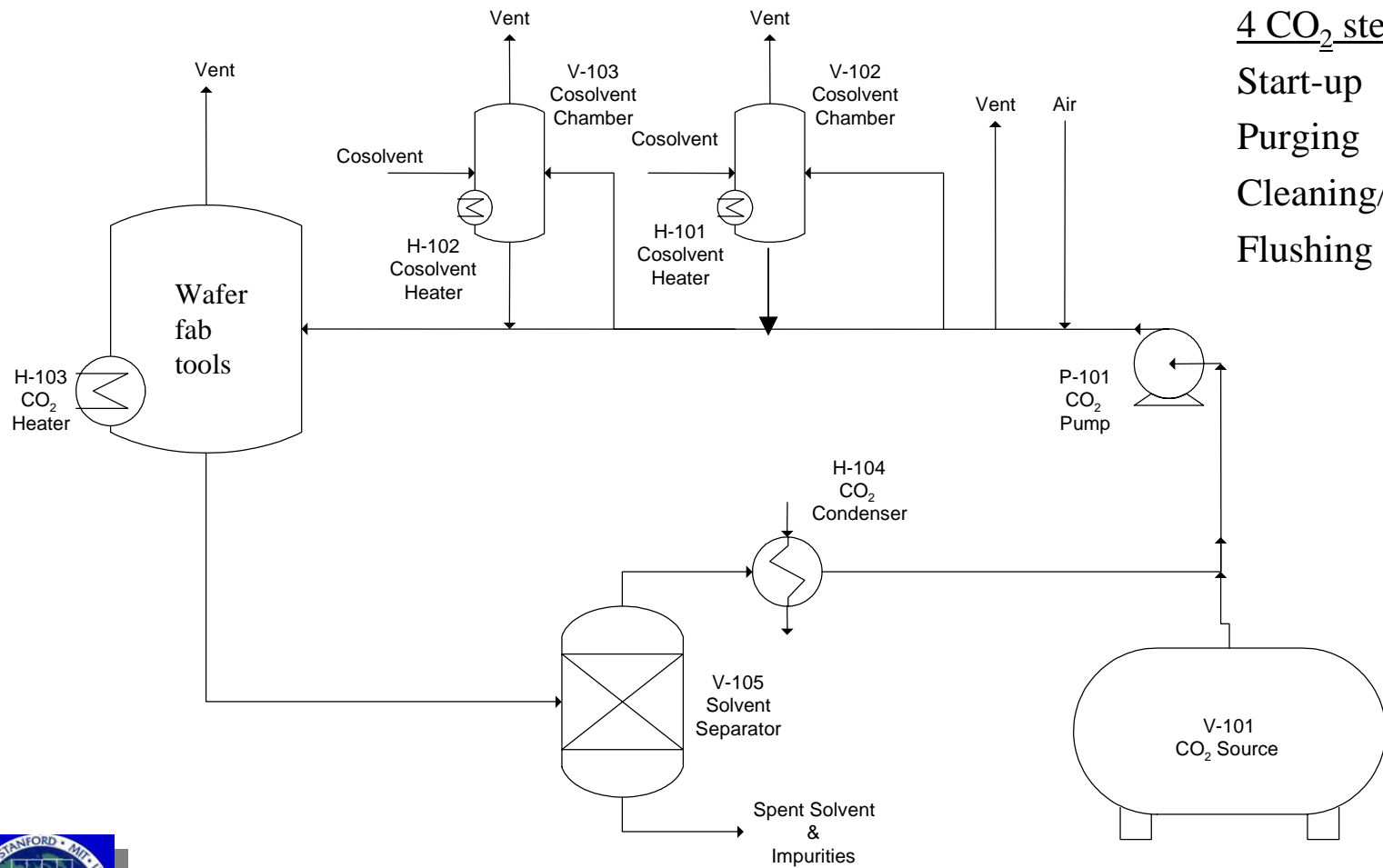


Photoresist removal and current process with water

>226,944
gallons per day
for a small
plant



Photoresist removal and supercritical CO₂ usage

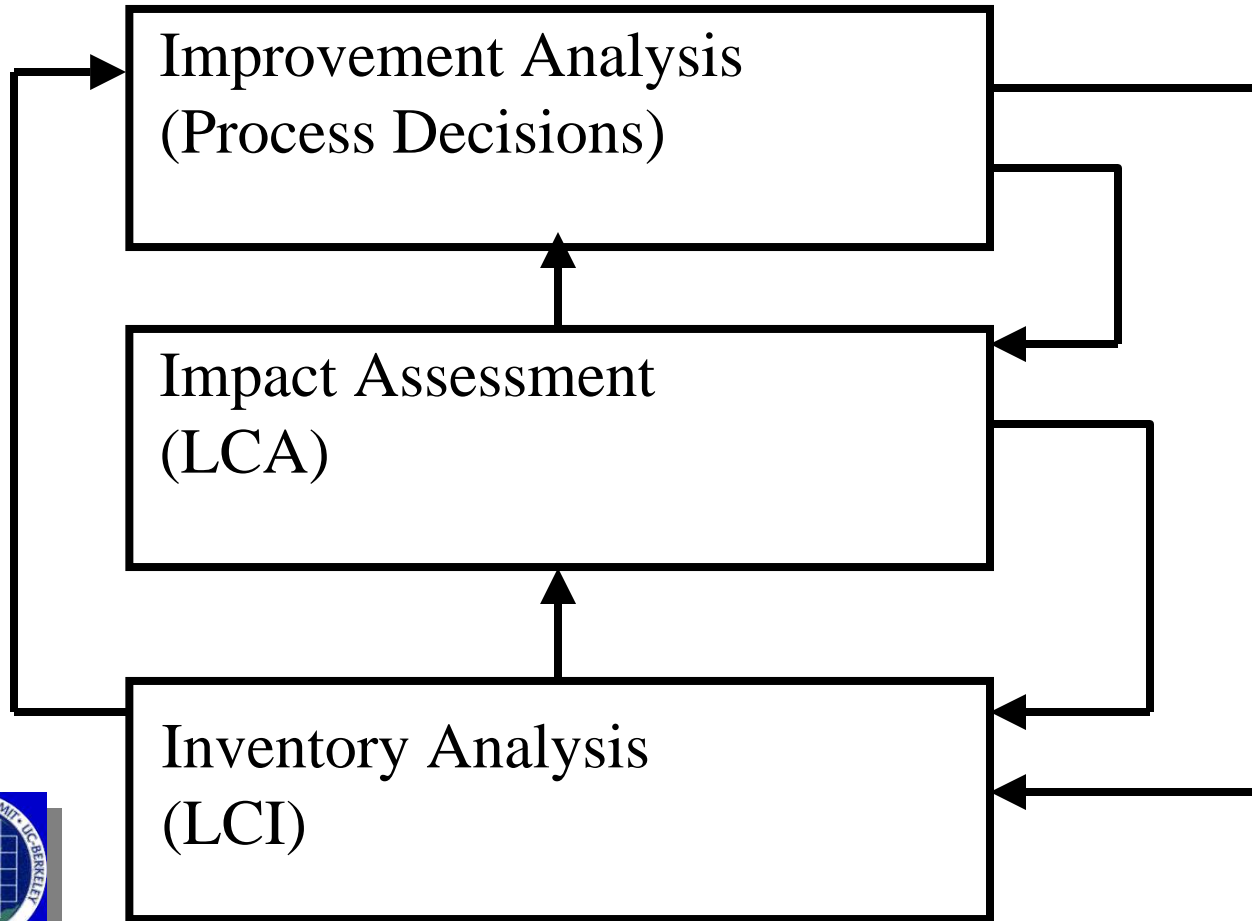


- 4 CO₂ steps
- Start-up
- Purging
- Cleaning/separating
- Flushing



Environmental Assessment Tools

Stage of Information Development



Feedback mechanisms



First Step to Generating an LCA

LCI comes before LCA in the information chain

Need to set boundaries of the investigation

Can impact results so clear boundaries are needed

This is a Gate-to-Gate study

Does not quantify upstream information

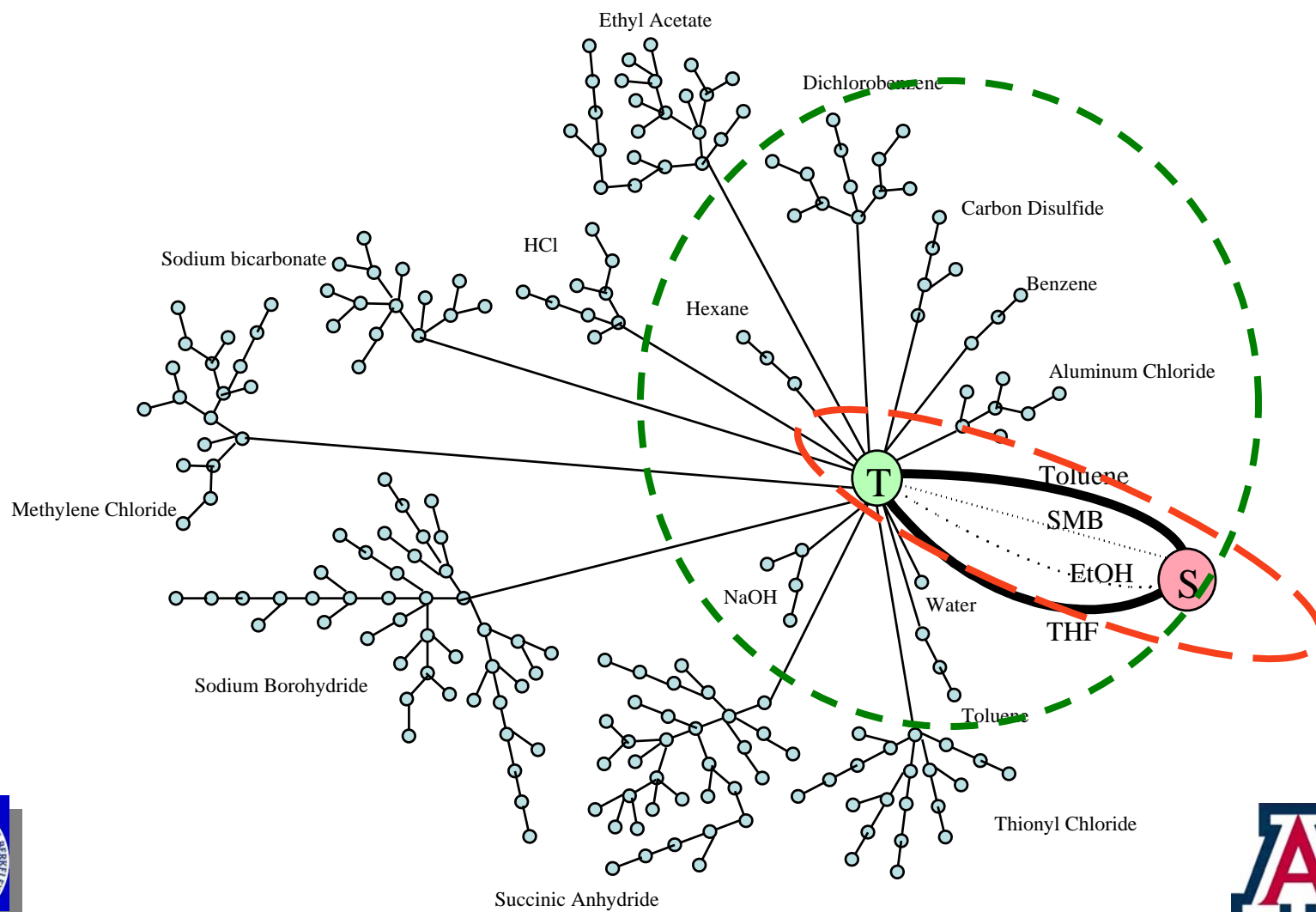
Does not quantify downstream information

Disposal of ion exchange resins (UPW)

This LCI will quantify materials usage for consumables, but not equipment (more important for UPW) and will quantify energy needed for each wafer per cleaning cycle



Importance of Boundaries



LCI - Gate to Gate and Limitations

Limitations to LCI only approach

No impacts yet - decisions may not be clear if there are conflicting environmental results

No economics yet - can be addressed by COO but requires more information

No upstream information - supplier concerns and deciding whether or not the gate-to-gate improvement is actually better overall

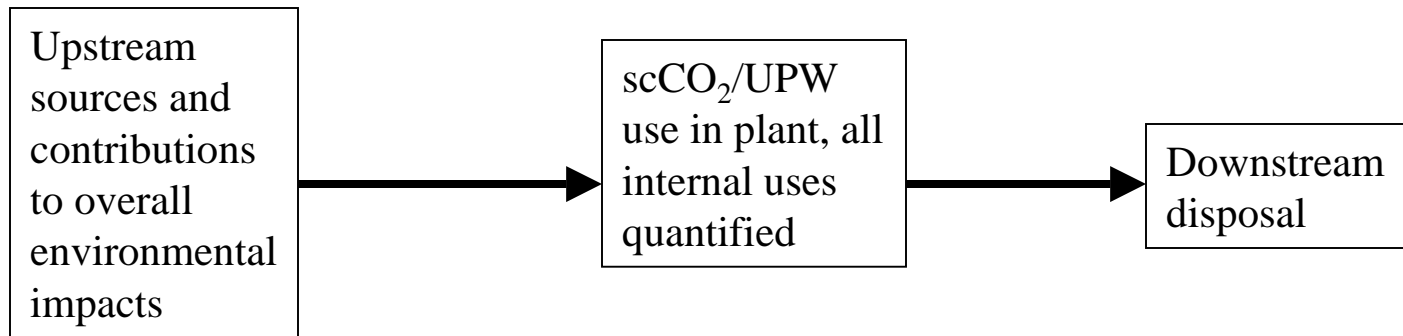
No post-use information - customer concerns and deciding whether impacts may be generated outside the factory boundary



Benefit = speed and still getting useful data



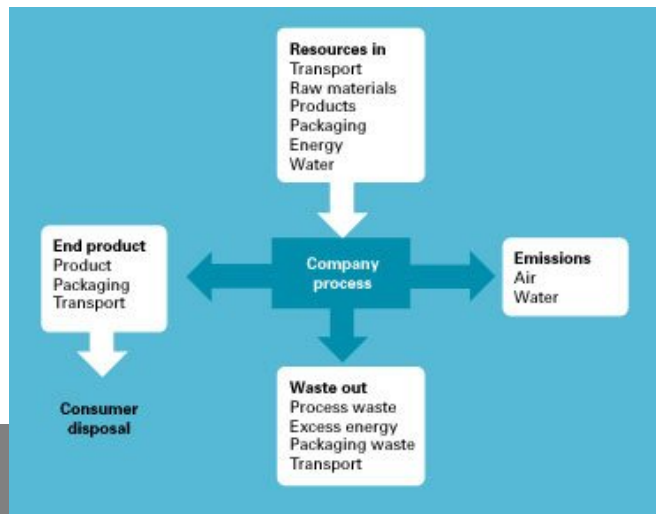
LCI - Gate to Gate



Cradle

Gate to Gate

Grave



Can build and verify Gate to Gate LCI/LCA faster due to the large decrease in required information.

Future work will expand the boundaries...more later about those impacts



Basis for numbers reported in this work: Assumptions and sources of data

US Patents Used: 6,306,564; 6,509,141; 6,319,410;
6,509,141; 6,562,146; 6,558,475

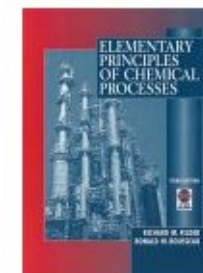
(patents can be vague →uncertainties in info.
Can be handled by methods introduced by McRae, MIT)

Physical properties from NIST Webbook, CRC Handbook
of Chemistry and Physics, Perry's Handbook.

Design heuristics from Seider, *et al.* (1999).

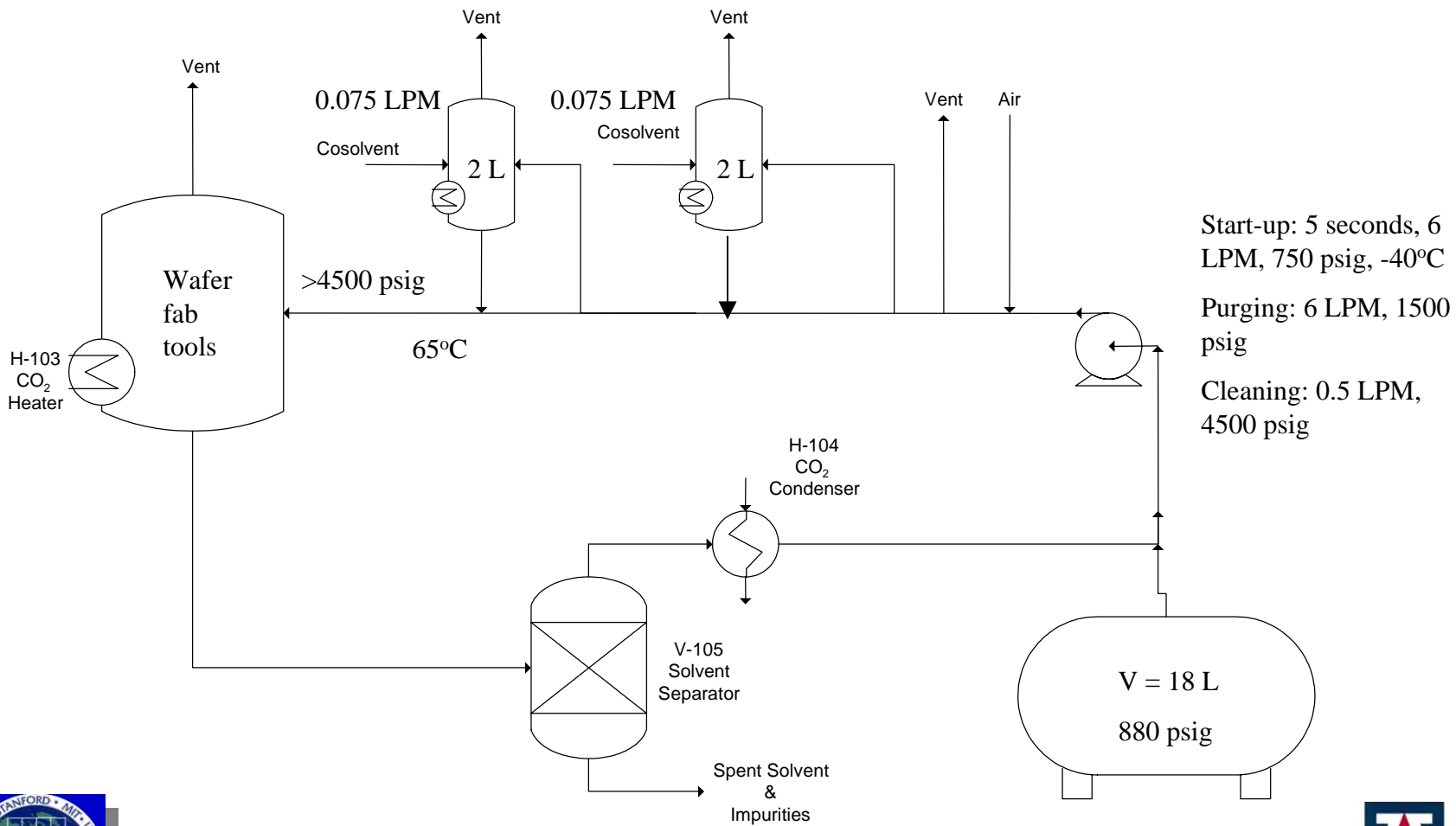
Heat transfer correlations from McCabe, *et al.* (2001)

Energy balance correlations for heats of vaporization,
Felder, *et al.* (2000)



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The flowsheet again with numbers and conditions



Assumptions Used in Calculations

Limited data for propylene carbonate heat capacities

Assumed linear function of C_p with T and expanded to T 's outside of measured range

Masses of CO_2 lost per cycle

Assumed that the total tank volumes of the system would need to be purged per cleaning cycle and this CO_2 lost

Number of wafer in each CO_2 cycle

No numbers given so assumed worst case scenario of 1 per cleaning cycle

An increase in this number reduces the impacts by that amount per wafer!



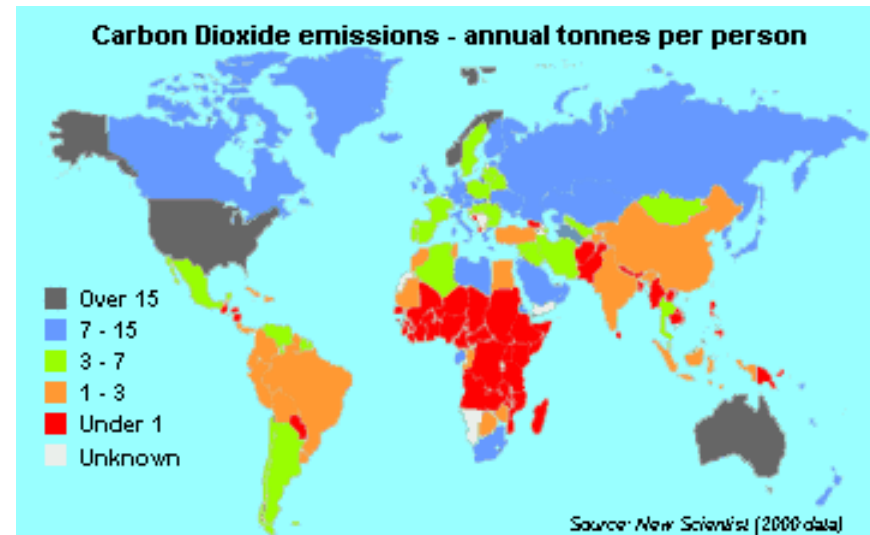
Material Balance Needs per Cycle

Per cleaning cycle, there will be some losses of CO₂ during start-up and purging.

Mass lost = 1.01 kg/cleaning cycle

There will be some propylene carbonate lost per cleaning cycle during separations unless this substance is purified from the contaminants and recycled.

Mass lost = 0.272 kg/cleaning cycle



May have emissions concerns if regulations on CO₂ become more stringent



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Energy (kJ) Estimates for Equipment (Assume 1 cycle = 1 wafer)

Processing Step	Piece of Equipment	Energy Duty (kJ/cycle)
Start-up	Pump	negligible
Purging	Heater	134.71
Clean and Separation	Cooler*	-151.46
	Pump	52.58
	Heater	173.70
	Separator heater	125.35
Flush	Cooler*	-97.33
	Pump	35.07
	Heater	98.57
	Separator heater	83.71
*Cooler (10°C)	Refrigeration cycle	298.28



Energy Estimates for Equipment (Assume 1 cycle = 1 wafer)

Total CO₂ pumping cost per cycle = 86.75 kJ

Energy cost of mixing per cycle = 0.02 kJ

Energy cost of heating pressure chamber and cosolvent vessels = 616.04 kJ

Cooling costs = 248.79 kJ

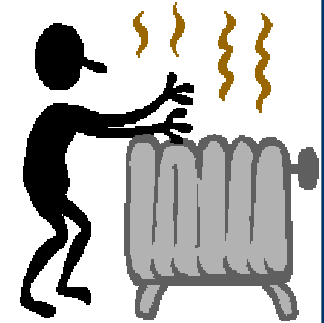
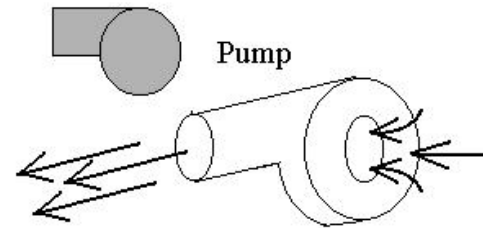
Costs for cooling shifted to refrigeration = 298.28 kJ

Total energy costs = 1001.97 kJ per cycle

Note: did not estimate the energy requirements of separation and recovery steps of cosolvent

Recovery of PCO₃ from the waste stream could be energy intensive
(not described in any patents or publications)

Largest energy costs are for heating the pressure chamber



Validation of Results So Far

Water is somewhat recyclable, but scCO_2 may be 100% recyclable due to ease of separations as sc conditions are removed \rightarrow less energy (separation costs)



All research shows CO_2 to be 100% recyclable

One company has verified that many of our estimates are in fact close to processing numbers \rightarrow assumptions are correct so far.

Some published information not available from national labs due to security concerns \rightarrow cannot verify results versus actual measurements and non-patent data



A Comparison to UPW Use

A typical fabrication facility will use approximately 2,000 gal of UPW to make one eight inch wafer with about 60% of the water being used in wafer rinsing

And, it takes about 46 kWh of energy to produce 1000 gal of UPW

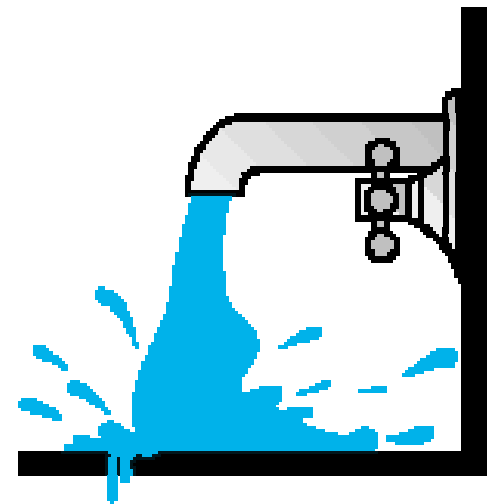
There are approximately 130 wafer rinsing steps in semiconductor manufacturing chains based on water usage per tool



A Comparison to UPW Use: Materials

30 to 40 percent of the UPW will be sent to the sewer after rinsing.

This water may be reused internally prior to sewerage, but it will still need to be replaced by fresh city water. This means that up to 480 gal (1817 kg) of water need to be provided for rinsing of each wafer processed, or **3.69 gal (13.97 kg)** per cycle per wafer .



A Comparison to UPW Use: Energy

Total Energy Requirements are 1,528 kJ/wafer/
cleaning cycle

This is an increase of 52% over the energy cost of
scCO₂ if only one wafer can be processed at a time,
but much larger than that if multiple wafers can be
cleaned.



Other LCI/LCA Impacts to Quantify if Boundaries are Expanded:

Trade-offs

There are no dedicated CO₂ distribution networks like there are for water. CO₂ will need to be transported by truck → fossil fuel depletion, smog formation, greenhouse gas emissions.

Disposal of CO₂ for equipment maintenance, leaks, etc., would add to CO₂ emissions.

Upstream manufacturing of scCO₂ of this high purity may add to energy costs during production → fossil fuel depletion, greenhouse gas emissions.

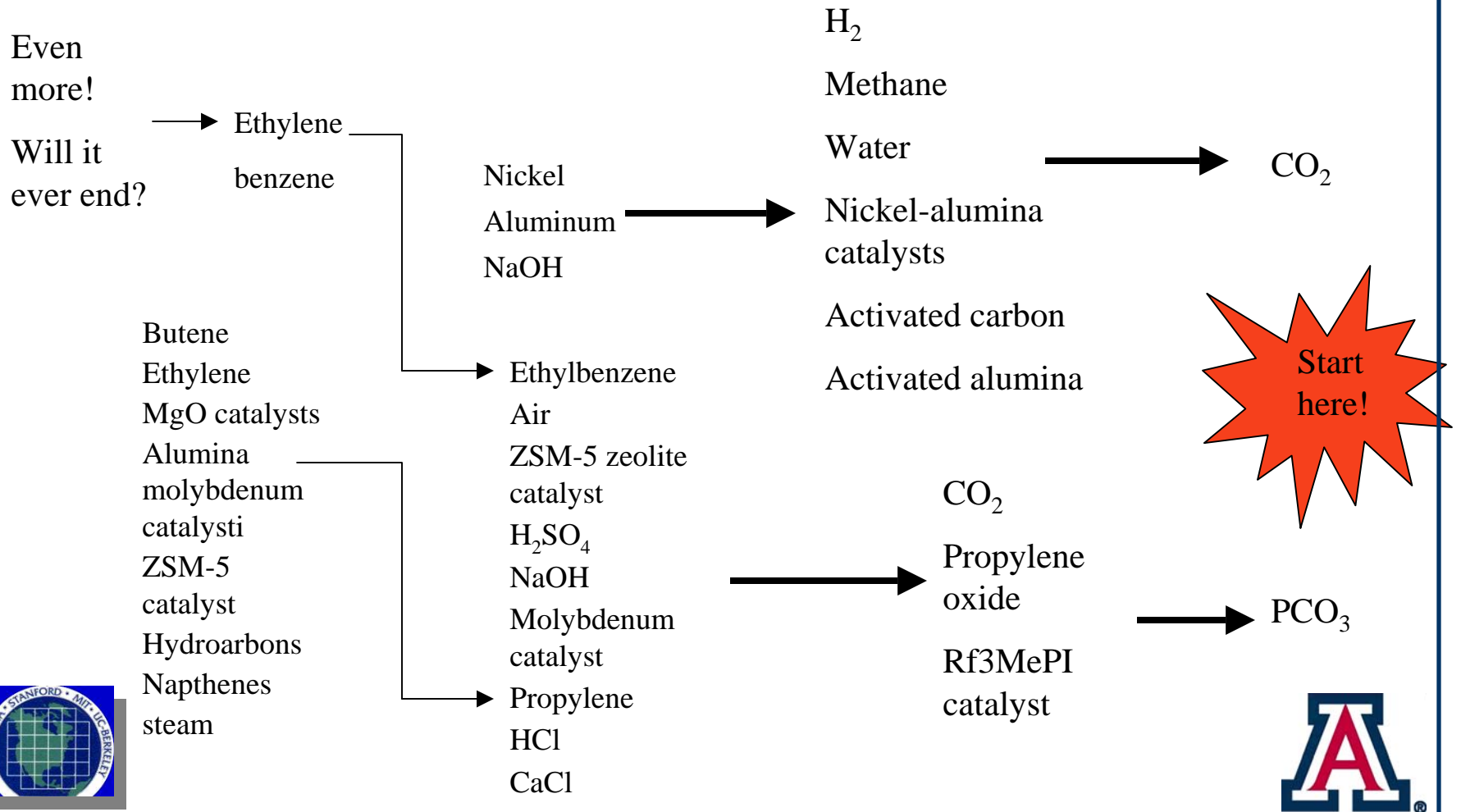
Water is a resource that is being depleted rapidly in many areas where semiconductor plants are located → nonrenewable resource depletion

Need to follow-up on PCO₃ recycling and separations to make sure they are 100% and what those costs are



Future Work: Expanding Boundaries

Expand LCA back upstream to quantify overall impacts from manufacturing CO₂:



Future Work: Cost of Ownership

The next step in making this work relevant is to complete a cost of ownership study to estimate the fixed and operating costs for the scCO₂ process.



Some information may be available from SC Fluids who has licensed the technology from Los Alamos National Labs.

The price of CO₂ and PCO₃ are both important to the economics since they are lost during manufacturing.



Future Work: External Decision Information Gathering

Money for large expansion of $scCO_2$ and PCO_3 use

PCO_3 is used as a reactive diluent to reduce cost in applications such as isocyanate (PMDI) wood binders / adhesives and urethane coatings / elastomers / adhesives.

A more recently discovered application for PCO_3 is in rechargeable lithium batteries. Eighty percent of a rechargeable lithium battery is the filler, PCO_3 .

How much can the market bear for increases?

Optimization of $scCO_2$ process - if costs are problematic, it may be necessary to optimize the process instead of just having it workable for this application.

Vendor collaborations to address concerns can address other COO and external information concerns.



Conclusions

scCO₂ has many advantages over UPW use for wafer rinsing

can recycle without contamination worries

has lower energy costs per cleaning cycle

Some disadvantages

CO₂ emissions during purge and start-up steps

transportation and high purity CO₂ costs may make CO₂ unfavorable from a full LCA perspective



Acknowledgments

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